

132  
**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARKS OFFICE**

In re Application of: ) Examiner: NGUYEN,  
Ko ) PHUONGCHI T  
Serial No.: 10/650,384 )  
Filed: 08/27/2003 )  
For: HIGH-SPEED LOW PROFILE )  
CABLE ASSEMBLY )  
 )  
 )  
 )

**CERTIFICATE OF MAILING**

I hereby certify that this correspondence is being  
deposited with the United States Postal Service with  
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Alexandria, VA22313-1450 on this

*Mar 28 2005*  
\_\_\_\_\_  
Signed: *Wei Te Chung*  
*Wei Te Chung*

**REQUEST FOR REFUND OF PUBLICATION FEE**

The Honorable Commissioner of Patents  
Alexandria, VA 22313-1450

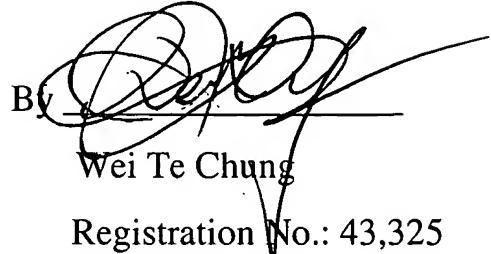
Sir:

The publication of USD300 was paid for the above-identified application  
under 37 CFR1.211(e) while the application was not published, as shown  
in attachments 1 and 2. Applicant therefore respectfully requests that the  
publication fee be refunded.

Respectfully submitted,

Ko

By



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10/650,384 HIGH-SPEED LOW PROFILE CABLE ASSEMBLY

## Transaction History

Date	Contents Description
11-02-2004	Recordation of Patent Grant Mailed
10-14-2004	Issue Notification Mailed
11-02-2004	Patent Issue Date Used in PTA Calculation
10-05-2004	Receipt into Pubs
10-01-2004	Dispatch to FDC
10-01-2004	Dispatch to FDC
10-01-2004	Application Is Considered Ready for Issue
09-24-2004	Mailroom Date of Issue Fee Payment
09-24-2004	Issue Fee Payment Recorded
08-18-2004	Receipt into Pubs
07-07-2004	Workflow - File Sent to Contractor
06-18-2004	Mail Notice of Allowance
06-16-2004	Notice of Allowance Data Verification Completed
06-16-2004	Notice of Allowability
05-05-2004	Case Docketed to Examiner in GAU
05-04-2004	Case Docketed to Examiner in GAU
12-01-2003	Case Docketed to Examiner in GAU
12-01-2003	Case Docketed to Examiner in GAU
11-29-2003	IFW TSS Processing by Tech Center Complete
11-29-2003	Reference capture on IDS
08-27-2003	Information Disclosure Statement (IDS) Filed
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11-20-2003	Application Is Now Complete
11-19-2003	Application Return from OIPE
11-19-2003	Application Return TO OIPE
11-19-2003	Application Dispatched from OIPE
11-19-2003	Application Is Now Complete
11-10-2003	Cleared by OIPE CSR
10-10-2003	IFW Scan & PACR Auto Security Review
08-27-2003	Initial Exam Team nn

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10/650,384 HIGH-SPEED LOW PROFILE CABLE ASSEMBLY

## Application Data

Application Number:	10/650,384	Customer Number:	-
Filing or 371 (c) Date:	08-27-2003	Status:	Patented Case
Application Type:	Utility	Status Date:	10-14-2004
Examiner Name:	NGUYEN, PHUONGCHI T	Location:	ELECTRONIC
Group Art Unit:	2833	Location Date:	-
Confirmation Number:	7172	Earliest Publication No:	-
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Class / Subclass:	439/607	Patent Number:	6,811,438
First Named Inventor:	David Ko , Cypress, CA	Issue Date of Patent:	11-02-2004
Title of Invention:	HIGH-SPEED LOW PROFILE CABLE ASSEMBLY		

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